# Reflectionless High Pass Filter

### **XHF2-Series**

50 $\Omega$  DC to 30 GHz

### The Big Deal

- Patented design eliminates in band spurs
- Pass band cut-off up to 18.3 GHz
- Stop band up to 30 GHz
- Excellent repeatability through IPD\* process



CASE STYLE: MC1630-1

#### **Product Overview**

Mini-Circuits' XHF2-Series reflectionless filters employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level which interact with neighboring components and often result in intermodulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

Key Features	Advantages				
Easy integration with sensitive reflective components, e.g. mixers, multipliers	Reflectionless filters absorb unwanted signals, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.				
Enables stable integration of wideband amplifiers	Because reflectionless filters maintain good impedance in the stop band; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.				
Cascadable	Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect pass band signals.				
Excellent power handling in a tiny surface mount device	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.				
Small size, 2x2mm QFN	Allows replacement of filter/attenuator pairs with a single reflectionless filter, sav- ing board space.				
Excellent repeatability of RF performance	Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.				
Excellent stability over temperature	With ±0.3 dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.				
Operating temperature up to 105°C	Suitable for operation close to high power components.				

\*IPD – Integrated Passive Device, is a GaAs semiconductor process



# Reflectionless High Pass Filter

50Ω 11.6 to 30 GHz

#### Features

- $\bullet$  Match to 50  $\!\Omega$  in the stop band, eliminates undesired reflections
- Cascadable
- Excellent Power handling
- Temperature stable, up to 105°C
- Small size, 2 x 2 mm
- Protected by US Patent No. 8,392,495

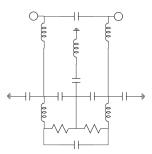
#### Applications

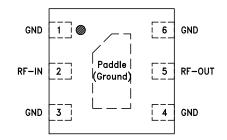
- Wi-Fi
- WiMax
- Microwave Radio
- Military & Space

#### **General Description**

Mini-Circuits' XHF2-1162+ reflectionless filter employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

#### simplified schematic and pad description





Function	Pad Number	Description
RF-IN	2	RF Input Pad
RF-OUT	5	RF Output Pad
GND	1,3,4,6, Paddle	Connected to ground externally



XHF2-1162+

Generic photo used for illustration purposes only CASE STYLE: MC1630-1

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

#### Electrical Specifications<sup>1</sup> at 25°C

Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
	Rejection	DC - F'	DC - 2500	—	6.9	—	
Stop Band	nejection	F' - F1	2500 - 8700	12.0	13.6	_	dB
Stop Band	Frequency Cut-off	F2	10400	—	2.9	—	
	VSWR	DC - F'	DC - 2500	_	2.7	_	:1
	voim	F' - F1	2500 - 8100	—	1.8	_	
	Insertion Loss	F3 - F4	11600 - 20000	—	1.6	—	dB
Pass Band	Insention Loss	F4 - F5	20000 - 30000	_	1.0	_	uв
	VSWR	F3 - F4	11600 - 20000	_	2.0	_	:1
		F4 - F5	20000 - 30000	—	1.9	—	

<sup>1</sup> Measured on Mini-Circuits Characterization Test Board TB-883-1162+

#### Absolute Maximum Ratings<sup>4</sup>

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband (F3-F5) <sup>2</sup>	1.26W at 25°C
RF Power Input, Stopband (DC-F3) <sup>3</sup>	0.25W at 25°C

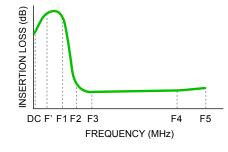
<sup>2</sup> Passband rating derates linearly to 0.63W at 105°C ambient
<sup>3</sup> Stopband rating derates linearly to 0.12W at 105°C ambient

<sup>4</sup> Permanent damage may occur if any of these limits are exceeded.

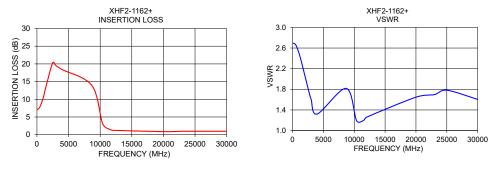
#### ESD rating

Human body model (HBM): Class 1A (250 to<500 V) in accordance with ANSI/ESD 5.1-2001





#### Typical Performance Data at 25°C Frequency (MHz) Insertion Loss VSWR (dB) (:1) 100 7.15 2.72 500 1000 8.10 10.75 2.67 2.49 1500 14.39 2.27 2500 3000 20.53 1.81 1.68 1.33 19.69 4000 18.62 8700 13.80 1.70 10400 11600 1.13 1.14 2.99 1.41 12000 1.22 1.20 20000 0.98 1.74 23000 25000 1.34 1.68 0.80 1.01 27000 0.97 1.49 30000 0.99 1.25

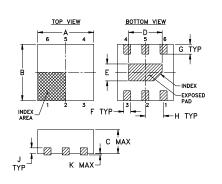


#### **⊒Mini-Circuits**⁵

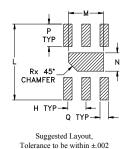
www.minicircuits.com P.O. Box 350166, Brooklyn, NY 11235-0003 (718) 934-4500 sales@minicircuits.com

## XHF2-1162+

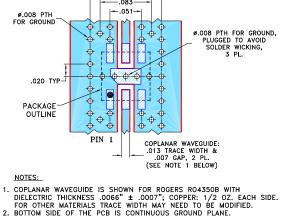
#### **Outline Drawing**



РСВ	Land	Pattern



Demo Board MCL P/N: TB-883-1162+ (without connectors) TB-883-1162C+ (with connectors) B20-118-F1+ Connector sold separately Suggested PCB Layout: PL-499+



DENOTES PCB COPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

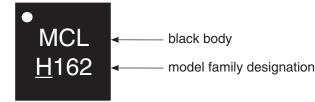
#### Outline Dimensions ( inch )

А	в	С	D	Е	F	G	н	J
0.079	0.079	0.039	0.047	0.024			0.026	0.008
2.00	2.00	1.00	1.20	0.60	0.25	0.35	0.65	0.20
K	L	М	N	Р	Q	R		wt
0.002	0.106	0.049	0.026	0.031	0.012	0.012		grams
0.05	2.70	1.25	0.65	0.80	0.30	0.30		0.006

#### **Tape & Reel Packaging**

DEVICE ORIENTATION IN T&R

#### **Product Marking**



DIRECTION OF FEED

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note		
8	4	7	Small quantity standard	20 50 100 200 500	
		7	Standard	1000, 2000	